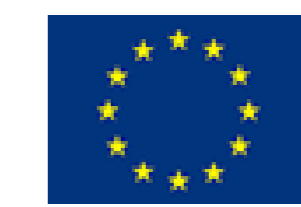


T. Offermans, M. Chrapa, J. Schleuniger, M. Zinggeler, W. H. Hughes, R. Ferrini, G. Nisato

CSEM Muttenz, Tramstrasse 99, CH-4132 Muttenz, Switzerland

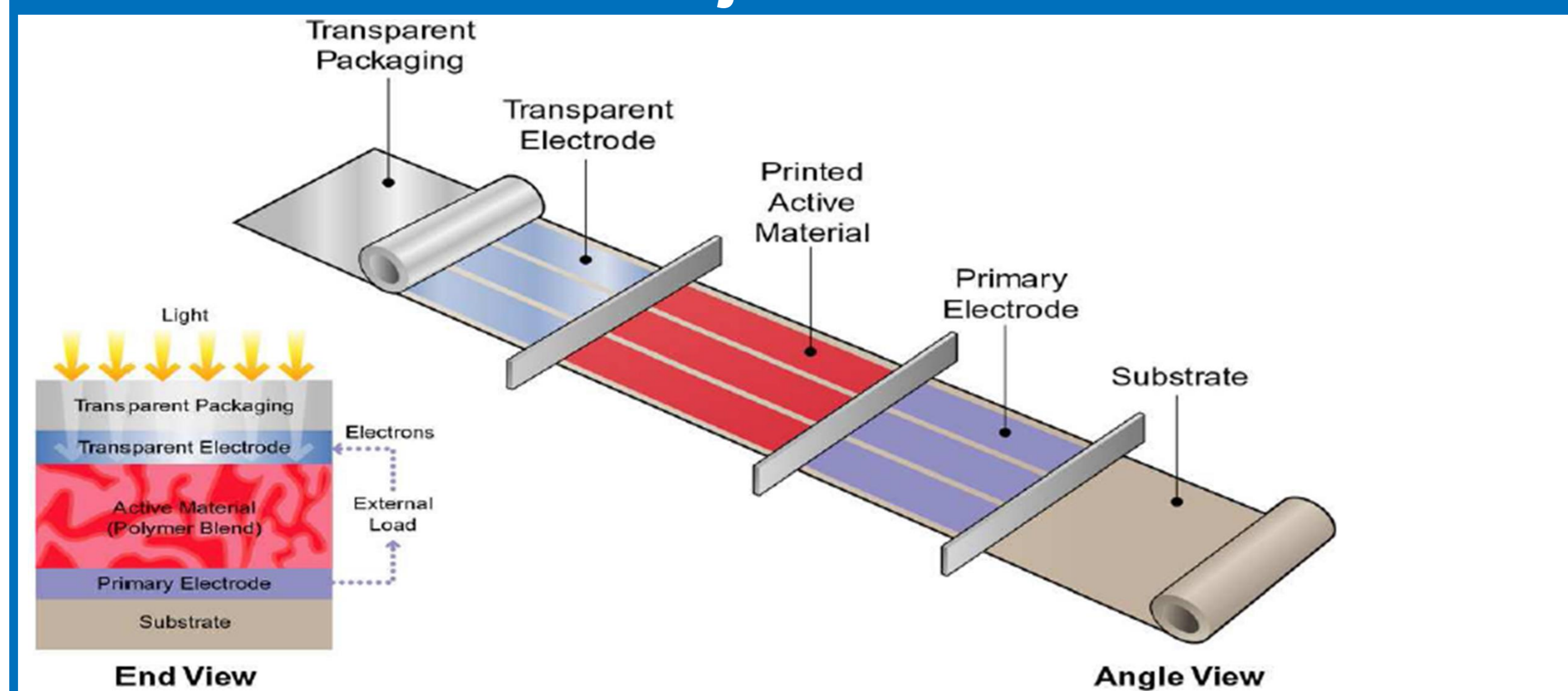
At CSEM Muttenz, we aim to demonstrate the feasibility of printing tandem modules using low cost mass production compatible printing techniques to fabricate fully printed tandem OPV modules. In the current work we have focused on deposition of the charge injection layers, the photoactive layers and the recombination layer by additive doctor blade coating.

We gratefully acknowledge the financial support by the European Commission in project **SUNFLOWER** (Nr. 287594) as well as by the Interreg project **RhinSolar**.



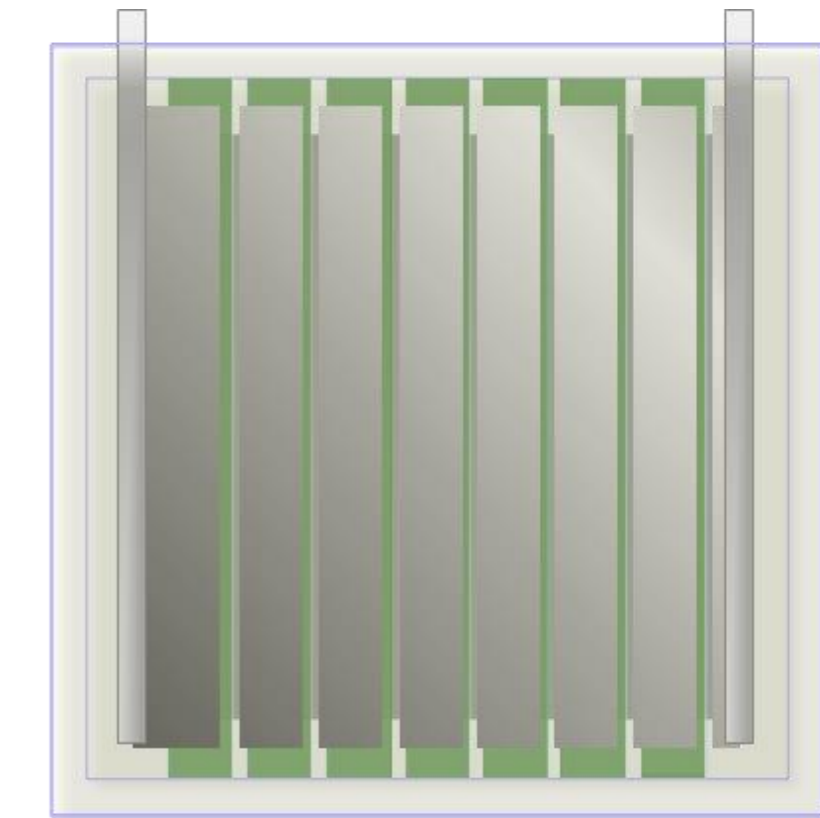
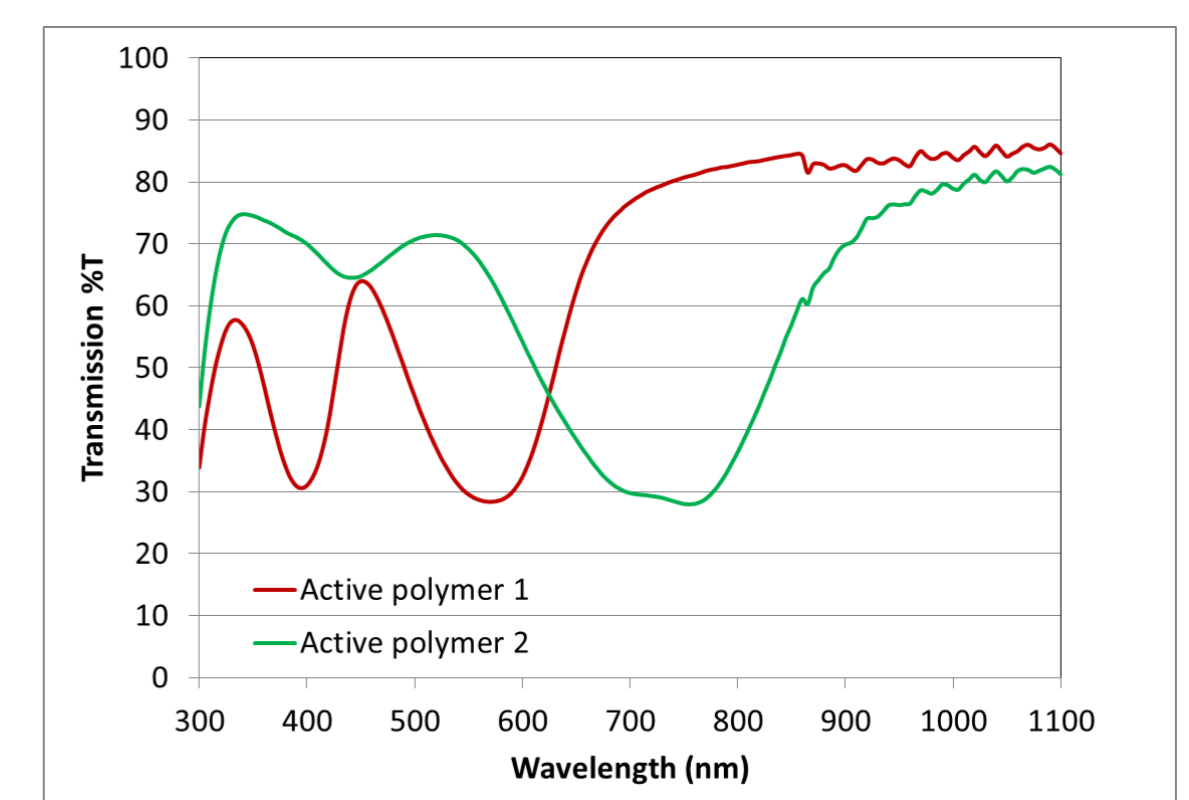
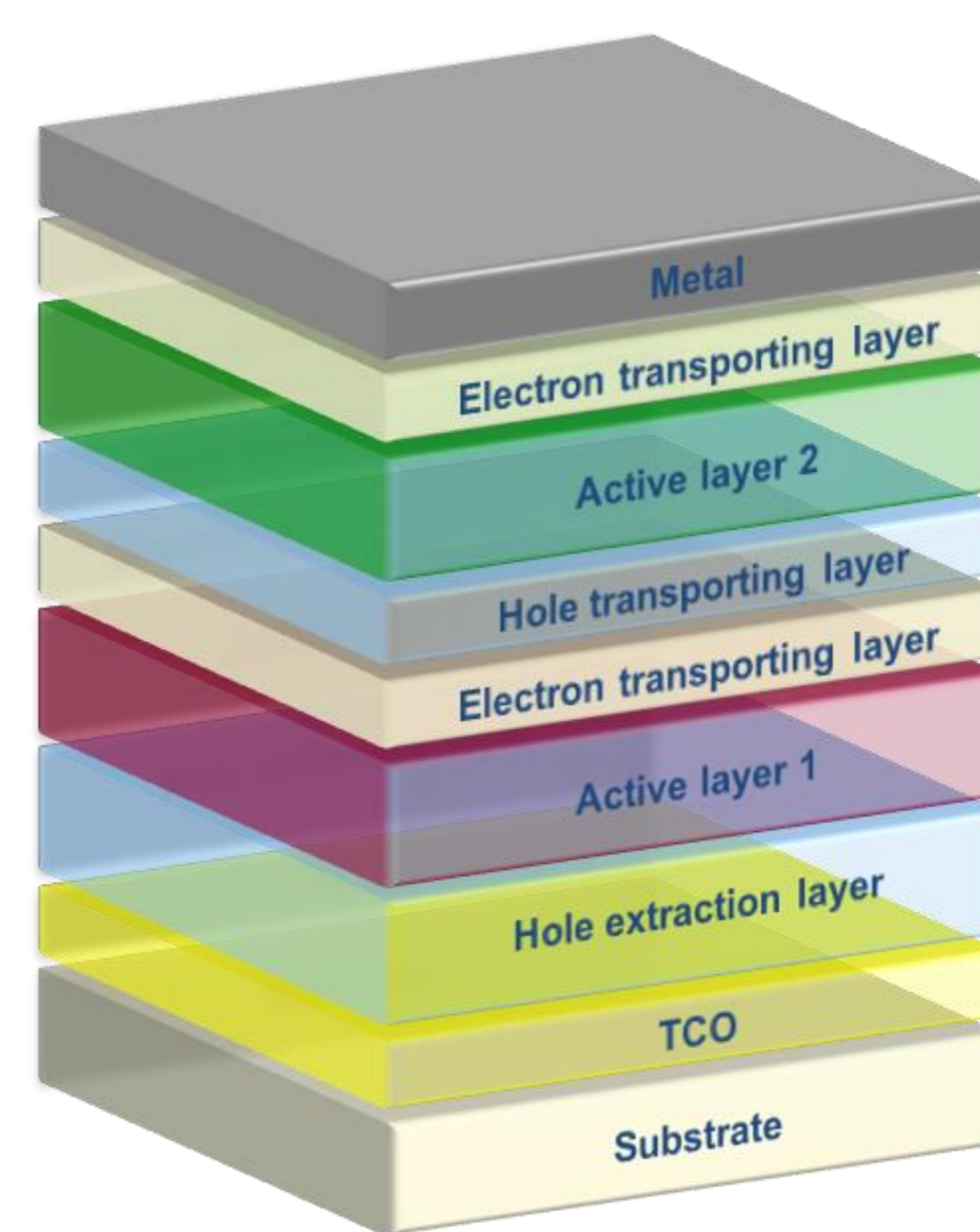
More details on the Sunflower project and partners can be found at the CSEM booth.

Objectives



Aim: To address the challenges that arise as materials and processes are transferred from the small laboratory scale to a larger production scale for all the individual components that are needed to manufacture tandem OPV modules at a high efficiency and low cost.

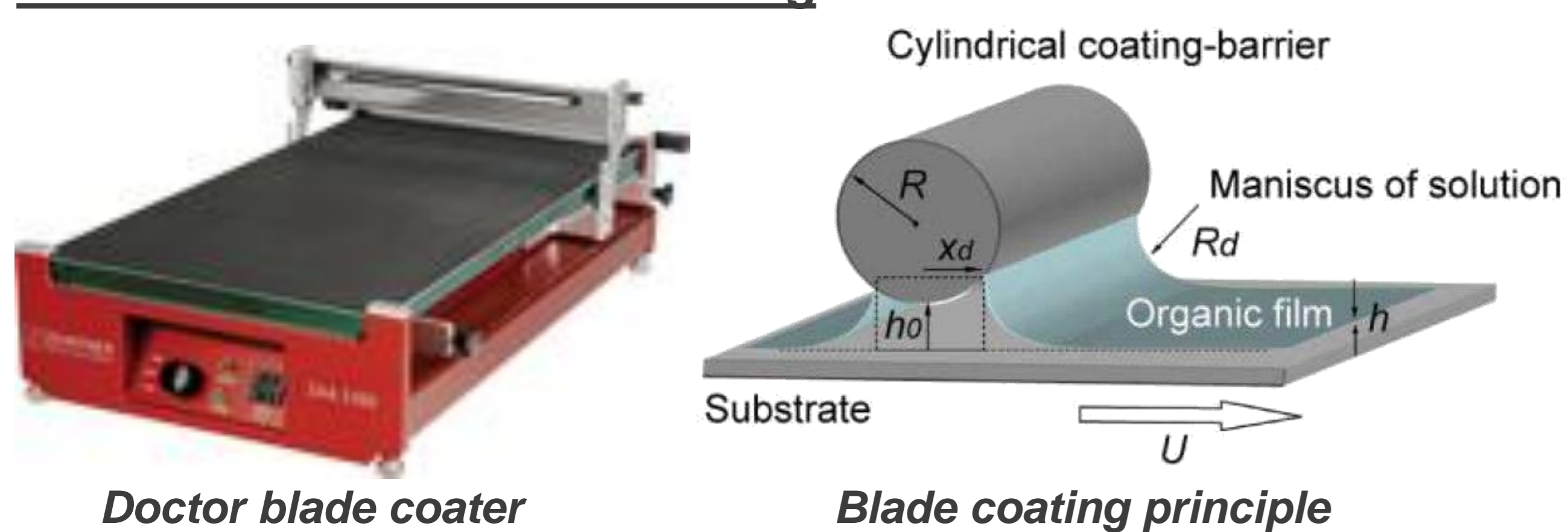
Design of the tandem stack



Fabrication methods

Using printing methods that are compatible to industrial, low cost, large scale production.

❖ **Method of choice: blade coating**



❖ **Ink-jet printing**

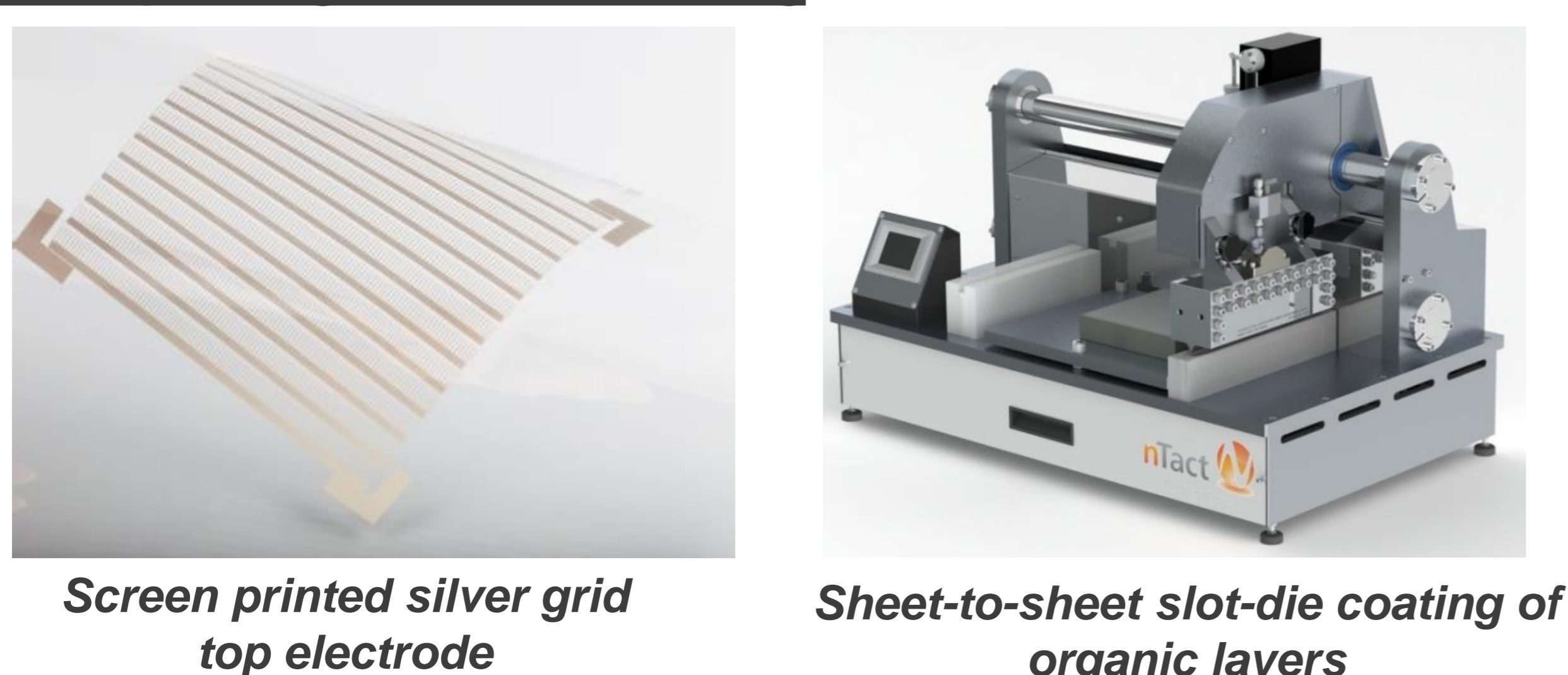


Pixdro multi nozzle ink-jet printer

Bottom or top silver grid electrode

ZnO interlayer for tandem module

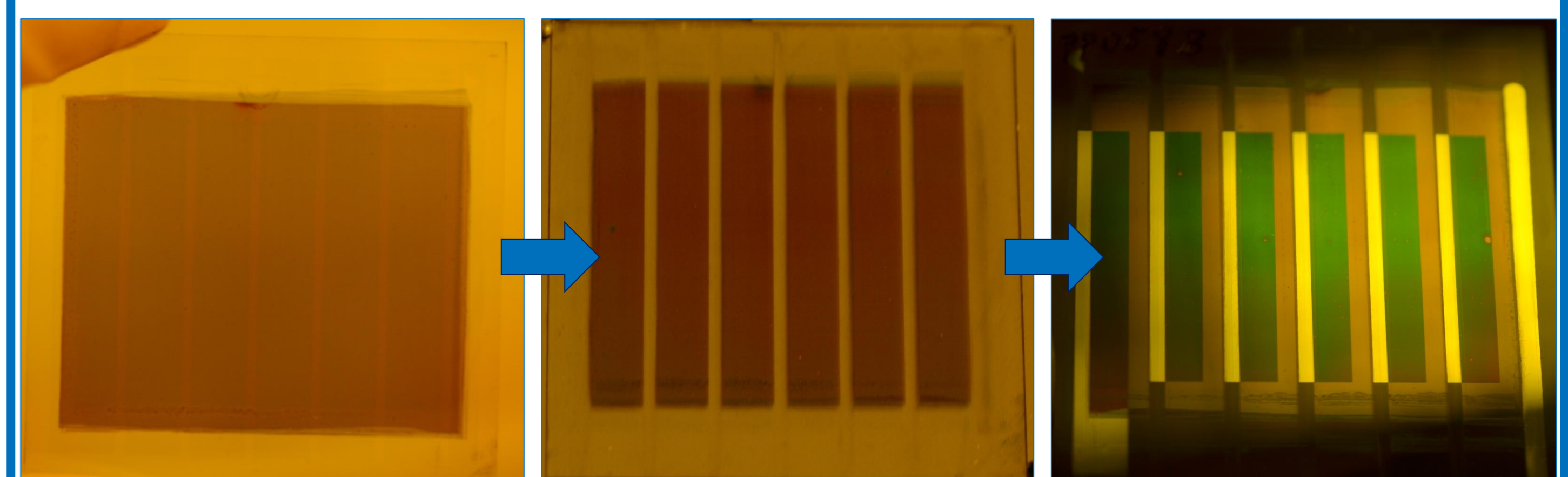
❖ **Screen printing & slot-die coating**



Screen printed silver grid top electrode

Sheet-to-sheet slot-die coating of organic layers

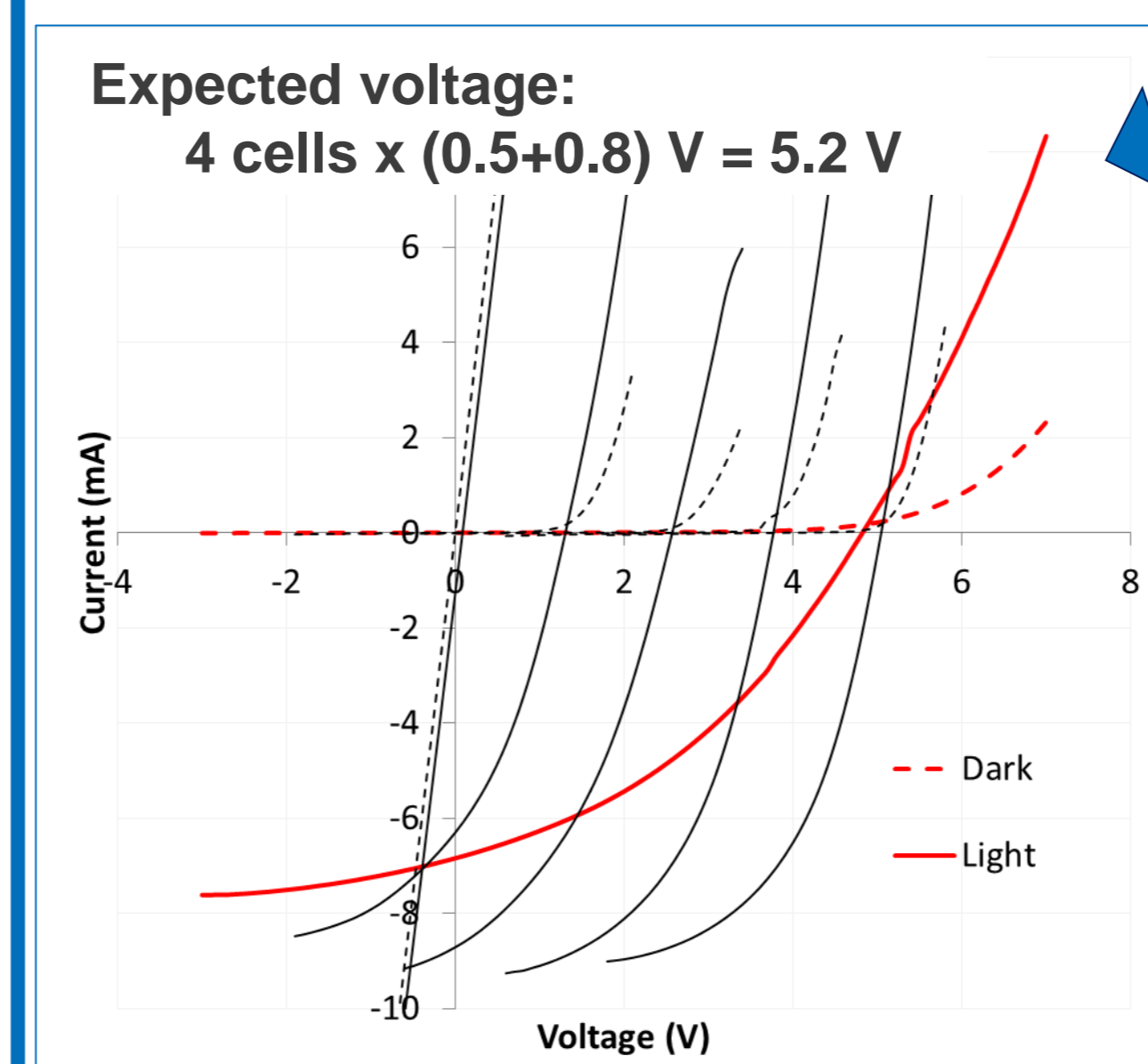
Fabrication & Result



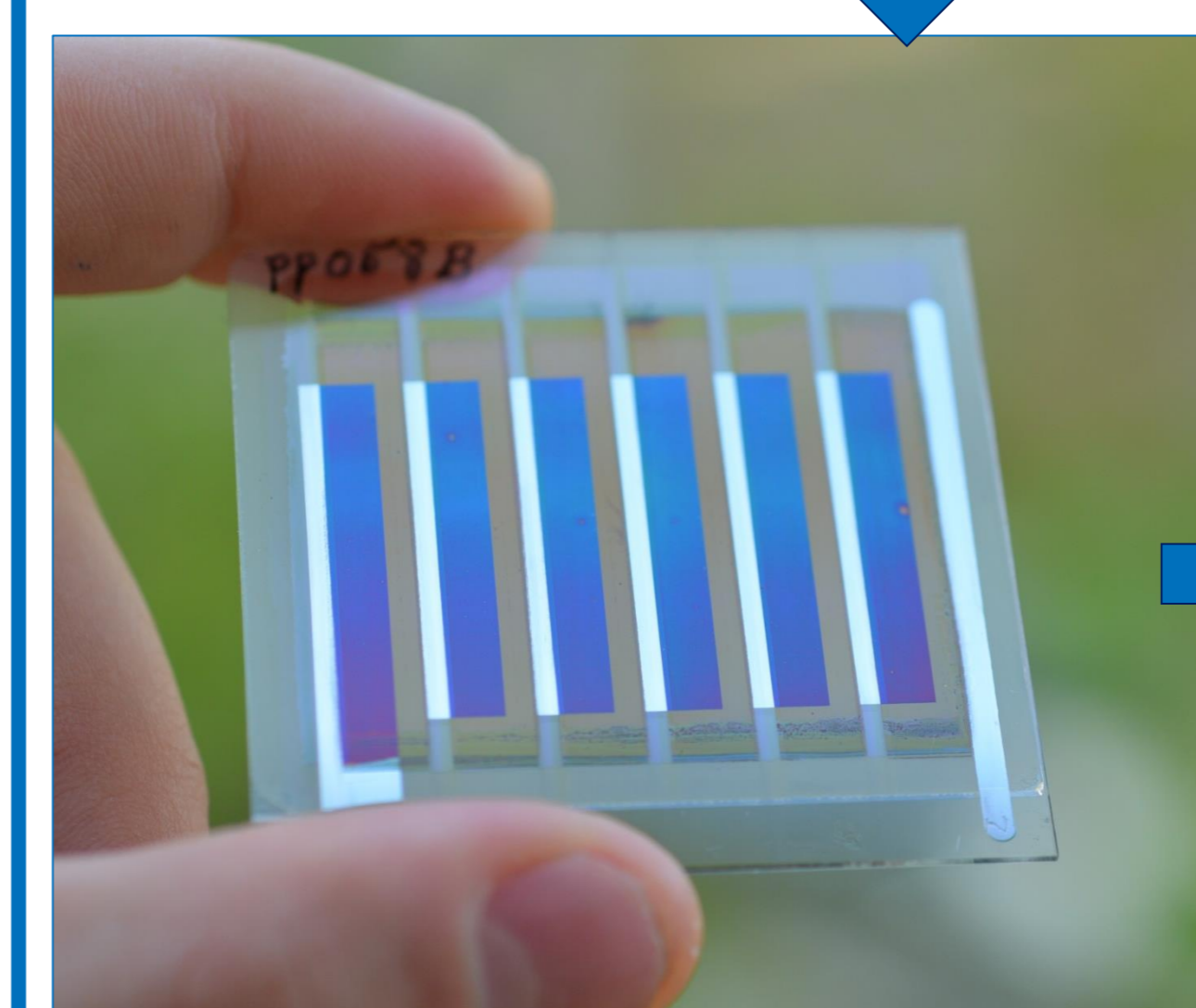
Step 1: Additive blade coating

Step 2: Layer patterning

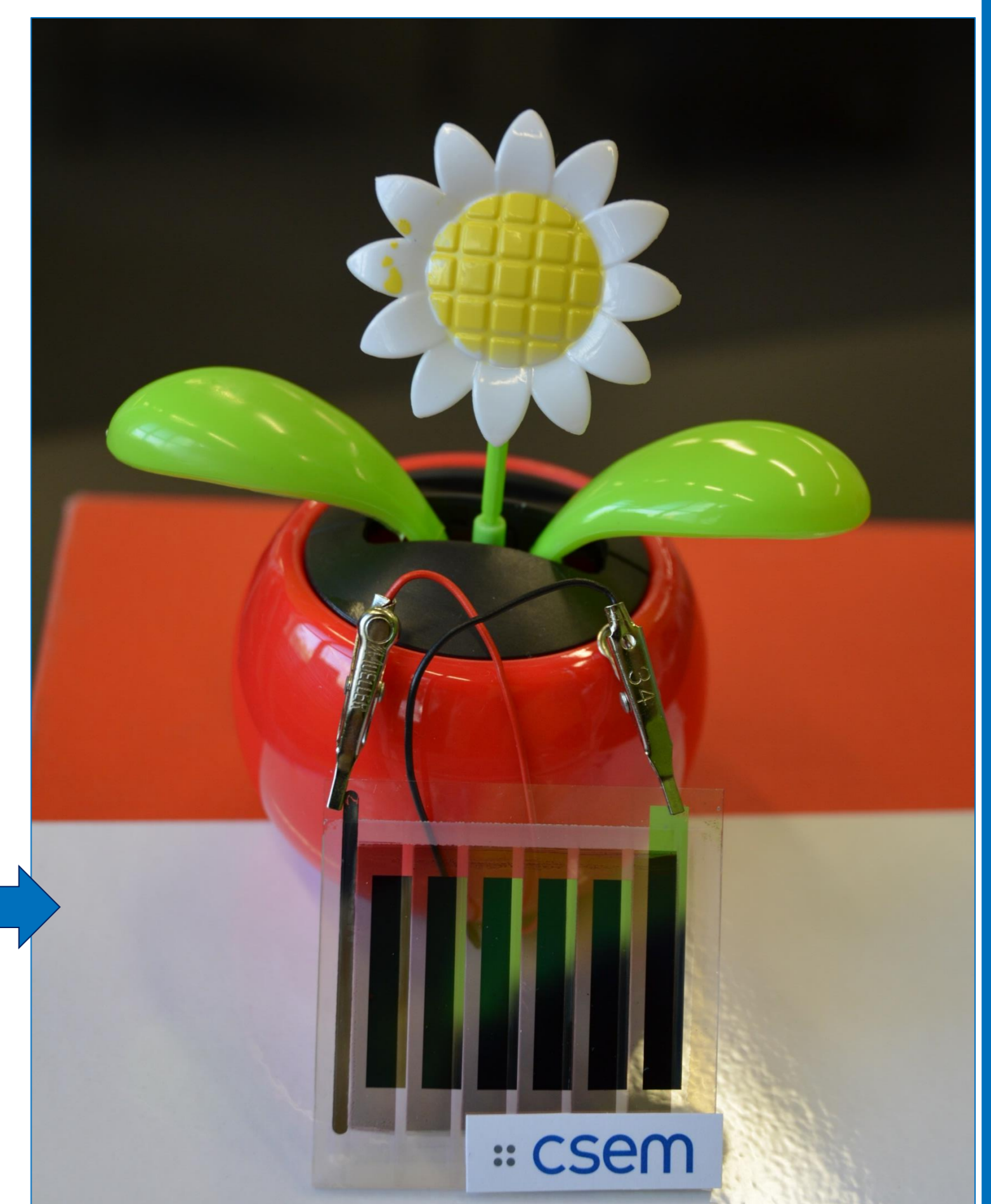
Step 3: Deposition of top electrode by thermal evaporation or screen printing



Step 4: JV-characterization



Step 5: Encapsulation



Step 6: Demonstration